

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE ATTORNEY DOCKET NO. 047071-0109

Harry A. ATWATER et al.

Title:

WAFER BONDED EPITAXIAL TEMPLATES FOR SILICON

**HETEROSTRUCTURES** 

Appl. No.:

10/784,586

Filing Date:

02/23/2004

Examiner:

Unassigned

Art Unit:

1764

## INFORMATION DISCLOSURE STATEMENT **UNDER 37 CFR §1.56**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Submitted herewith on Form PTO/SB/08 is a listing of a document known to Applicant in order to comply with Applicant's duty of disclosure pursuant to 37 CFR §1.56. A copy of each non-U.S. patent document and each non-patent document is being submitted to comply with the provisions of 37 CFR §1.97 and §1.98.

The submission of any document herewith, which is not a statutory bar, is not intended as an admission that such document constitutes prior art against the claims of the present application or that such document is considered material to patentability as defined in 37 CFR §1.56(b). Applicants do not waive any rights to take any action which would be appropriate to antedate or otherwise remove as a competent reference any document which is determined to be a prima facie art reference against the claims of the present application.

## **TIMING OF THE DISCLOSURE**

The listed documents are being submitted in compliance with 37 CFR §1.97(b), before the mailing date of the first Office Action on the merits.

## RELEVANCE OF EACH DOCUMENT

An English translation of the foreign-language document is not readily available; however, an English language abstract is attached herewith. The absence of such translation does not relieve the PTO from its duty to consider the submitted documents (37 CFR §1.98 and MPEP §609).

Applicants respectfully request that any listed document be considered by the Examiner and be made of record in the present application and that an initialed copy of Form PTO/SB/08 be returned in accordance with MPEP §609.

The Commissioner is hereby authorized to charge any additional fees which may be required regarding this application under 37 CFR §§ 1.16-1.17, or credit any overpayment, to Deposit Account No. 19-0741. Should no proper payment be enclosed herewith, as by a check being in the wrong amount, unsigned, post-dated, otherwise improper or informal or even entirely missing, the Commissioner is authorized to charge the unpaid amount to Deposit Account No. 19-0741.

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Respectfully submitted,

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Approved for use through 10/31/2002. OMB 0651-0031

U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

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control number.					PE		
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	INFORMATION	DISCLO	OSURE	Application Number	10/784,586	F 000F	
	STATEMENT BY APPLICANT			Filing Date	02/23/2004	NOV 1 5 2005 W	
				First Named Inventor	Harry A. ATWATE	R <sub>e</sub> et al.	
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(use as many sheets as necessary)			ecessary)	Examiner Name	Unassigned	TRADE	
Sheet	1	of	1	Attorney Docket Number	047071-0109		

U.S. PATENT DOCUMENTS						
Examiner Initials*	Cite No.1	U.S. Patent Document			Date of Publication of	Pages, Columns, Lines, Where Relevant
		Number	Kind Code <sup>2</sup> (if known)	Name of Patentee or Applicant of Cited Document	Cited Document MM-DD-YYYY	Passages or Relevant Figures Appear
	B1	5,013,681		GODBEY et al.	05-07-1991	
	B2	5,217,564		BOZLER et al.	06-08-1993	
	В3	5,391,257		SULLIVAN et al.	02-21-1995	
	B4	5,637,187		TAKASU et al.	06-10-1997	
	B5	5,641,381		BAILEY et al.	06-24-1997	
	B6	5,710,057		KENNEY	01-20-1998	
	B7	6,020,252		ASPAR et al.	02-01-2000	
	B8	6,103,597		ASPAR et al.	08-15-2000	
	B9	6,211,738		SAKAGUCHI et al	04-24-2001	
	B10	6,242,324		KUB et al.	06-05-2001	
	B11	6,323,108		KUB et al.	11-27-2001	
	B12	6,328,796		KUB et al.	12-11-2001	
	B13	6,429,104		AUBERTON-HERVE	08-06-2002	
	B14	6,497,763		KUB et al.	12-24-2002	
	B15	2003/0064535		KUB et al.	04-03-2003	
	B16	6,794,276		LETERTRE et al.	09-21-2004	
	B17	6,815,309		LETERTRE et al.	11-09-2004	
	B18	2004/0235268		LETERTRE et al.	11-25-2004	
	B19	2005/0032330		GHYSELEN et al.	02-10-2005	-
	B20	6,867,067		GHYSELEN et al.	03-15-2005	
-	B21	6,908,828		LETERTRE et al.	06-21-2005	

			U.S. PATENT APPLICATIONS		
Examiner Cite No.1	U.S. Application Document	Name of Patentee or Applicant of	Filing Date if	Pages, Columns, Lines, Where Relevant	
	Number	Cited Document	Appropriate MM-DD-YYYY	Passages or Relevant Figures Appear	
	B22	10/761,918	ATWATER et al.	01/20/2004	
1.2	B23	11/004,808	ATWATER et al.	12/07/2004	
	B24	11/004,948	ATWATER et al.	12/07/2004	

				FOREIGN PATENT DOCUMENTS			
Examiner Initials*	Cite No. <sup>1</sup>	Foreign Patent D	Oocument Kind Code <sup>5</sup> (if known)	Name of Patentee or Applicant of Cited Documents	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T <sup>6</sup>
	B25	JP 03-270220		FUJITSU LTD.	02/12/1991		Abst.

NON PATENT LITERATURE DOCUMENTS						
Examiner Initials*	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.) date, page(s), volume-issue number(s), publisher, city and/or country where published.	T			
	B26	WELDON et al., "Mechanism of Sílicon Exfoliation Induced by Hydrogen/Helium Co-Implantation," Applied Physics Letters, Vol. 73, No. 25, December 21, 1998, pgs. 3721-3723.				

Examiner Signature

Date Considered

<sup>\*</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>&</sup>lt;sup>1</sup> Unique citation designation number. <sup>2</sup>See attached Kinds of U.S. Patent Documents. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup>For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup>Applicant is to place a check mark here if English language Translation is attached.